### 502459242 08/15/2013

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Liang-Yao Lee	08/08/2013
Jyh-Kang Ting	08/08/2013
Tsung-Chieh Tsai	08/08/2013
Juing-Yi Wu	08/12/2013

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### PROPERTY NUMBERS Total: 1

	Property Type	Number
Ap	plication Number:	13967477

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ATTORNEY DOCKET NUMBER:	TSMCP321US
NAME OF SUBMITTER:	Thomas G. Eschweiler
	PATENT

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Signature:	/Thomas G. Eschweiler/
Date:	08/15/2013
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U.S. Patent Appln. No. Filing Date:

### PATENT ASSIGNMENT

## PARTIES TO THE ASSIGNMENT

### Assignor(s):

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#### Assignee:

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#### **AGREEMENT**

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled "METHOD FOR PREVENTING PHOTORESIST CORNER ROUNDING EFFECTS" for which:

a non-provisional application for United States Letters Patent:

was executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration and Power of Attorney); or

TSMC Docket No. TSMC 2013-0592

Docket No.TSMCP321US

U.S. Patent Appln. No. Filing Date:

was filed on and accorded U.S. Serial No; or
will be filed without this executed PATENT ASSIGNMENT. ASSIGNOR hereby
authorizes and requests ASSIGNEE'S legal representatives, the attorneys
associated with Customer No, to insert below in this document this
APPLICATION's U.S. Serial Number and filing date, when known:
U.S. Serial No,
filed on

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S)

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Filing Date:

U.S. Patent Appln. No.

hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

2013/08/08

Date

Name 1<sup>st</sup> Inventor Liang-Yao Lee

tie:

TSMC Docket No. TSMC 2013-0592

Docket No.TSMCP321US

U.S. Patent Appln. No.

Filing Date:

Name

TSMC Docket No. TSMC 2013-0592

Docket No.TSMCP321US

U.S. Patent Appln. No. Filing Date:

Date Date

Name 3rd Inventor Tsung-Chieh Tsai

PATENT REEL: 031015 FRAME: 0903

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U.S. Patent Appln. No. Filing Date:

8/12 >013

Date

Name 4<sup>th</sup> Inventor Juing-Yi Wu

PATENT REEL: 031015 FRAME: 0904

**RECORDED: 08/15/2013**